

## **Description**

The AP2P052N uses advanced trench technology to provide excellent R<sub>DS(ON)</sub>, low gate charge and operation with gate voltages as low as 2.5V.

This device is suitable for use as a

Battery protection or in other Switching application.



### **General Features**

 $V_{DS} = -20V, I_{D} = -5A$ 

 $R_{DS(ON)} < 45 m\Omega$  @  $V_{GS}$ =4.5V

## **Application**

Power management

High power and current handing capability Lead free product is acquired Surface mount package PWM applications Load switch

P-Channel MOSFET

## **Package Marking and Ordering Information**

Product ID	Pack	Marking	Qty(PCS)
AP2P052N	SOT-23(SOT-23S)	A5SHB XXXX	3000PCS

## Absolute Maximum Ratings (T<sub>A</sub>=25℃ unless otherwise noted)

Symbol	Parameter	Limit	Unit
V <sub>DS</sub>	Drain-Source Voltage	-20	V
V <sub>G</sub> s	Gate-Source Voltage	±12	V
Ι <sub>D</sub>	Drain Current-Continuous	-5	А
Ідм	Drain Current-Pulsed (Note 1)	-14	А
Po	Maximum Power Dissipation	1.31	W
T <sub>J</sub> ,T <sub>STG</sub>	Operating Junction and Storage Temperature Range	-55 To 150	$^{\circ}$
Reja	Thermal Resistance,Junction-to-Ambient (Note 2)	120	°C/W



# Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
$BV_{DSS}$	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =-250uA	-20			V	
$\triangle BV_{DSS}/\triangle T_{J}$	BV <sub>DSS</sub> Temperature Coefficient	Reference to 25°C , I <sub>D</sub> =-1mA		-0.014		V/°C	
		V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-4.9A		35	45	mΩ	
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =-2.5V , I <sub>D</sub> =-3.4A		45	60		
		V <sub>GS</sub> =-1.8V , I <sub>D</sub> =-2A		65	85		
$V_{GS(th)}$	Gate Threshold Voltage	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =-250uA	-0.4		-1.0	V	
$\triangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	V <sub>GS</sub> -V <sub>DS</sub> , I <sub>D</sub> 250uA		3.95		mV/°C	
	Drain-Source Leakage Current	V <sub>DS</sub> =-16V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C			-1	uA	
I <sub>DSS</sub>	Diam-Source Leakage Current	V <sub>DS</sub> =-16V , V <sub>GS</sub> =0V , T <sub>J</sub> =55°C			-5		
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}=\pm 12V$ , $V_{DS}=0V$			±100	nA	
gfs	Forward Transconductance	$V_{DS}$ =-5V , $I_{D}$ =-3A		12.8		S	
Qg	Total Gate Charge (-4.5V)			10.2	14.3		
$Q_{gs}$	Gate-Source Charge	V <sub>DS</sub> =-15V , V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-3A		1.89	2.6	nC	
$Q_{gd}$	Gate-Drain Charge			3.1	4.3		
T <sub>d(on)</sub>	Turn-On Delay Time			5.6	11.2		
T <sub>r</sub>	Rise Time	V <sub>DD</sub> =-10V , V <sub>GS</sub> =-4.5V ,		40.8	73	ns	
T <sub>d(off)</sub>	Turn-Off Delay Time	$R_G=3.3\Omega$ , $I_D=-3A$		33.6	67		
T <sub>f</sub>	Fall Time			18	36		
C <sub>iss</sub>	Input Capacitance			857	1200		
Coss	Output Capacitance	V <sub>DS</sub> =-15V , V <sub>GS</sub> =0V , f=1MHz		114	160	pF	
C <sub>rss</sub>	Reverse Transfer Capacitance			108	151		
Is	Continuous Source Current <sup>1,4</sup>	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			-4.9	Α	
I <sub>SM</sub>	Pulsed Source Current <sup>2,4</sup>	vg-vD-0v , roice Current			-14	Α	
V <sub>SD</sub>	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =-1A , T <sub>J</sub> =25°C			-1	V	
t <sub>rr</sub>	Reverse Recovery Time	IF=-3A , di/dt=100A/μs ,		21.8	-	nS	
Q <sub>rr</sub>	Reverse Recovery Charge	T <sub>J</sub> =25°C		6.9		nC	

#### Note

<sup>1.</sup>The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.

<sup>2.</sup>The data tested by pulsed , pulse width  $\leqq$  300us , duty cycle  $\leqq$  2%

<sup>3.</sup>The power dissipation is limited by 150°C junction temperature

<sup>4.</sup> The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.



## **Typical Characteristics**

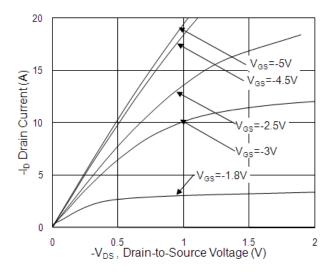


Fig.1 Typical Output Characteristics

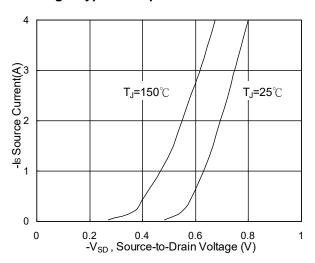


Fig.3 Forward Characteristics of Reverse

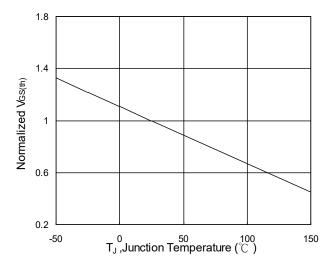


Fig.5 Normalized  $V_{GS(th)}$  vs.  $T_J$ 

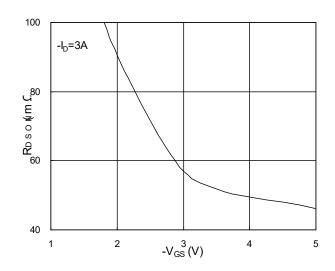


Fig.2 On-Resistance vs. G-S Voltage

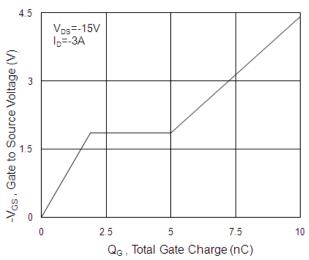


Fig.4 Gate-charge Characteristics

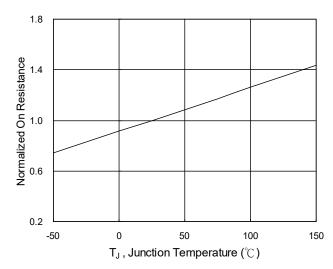
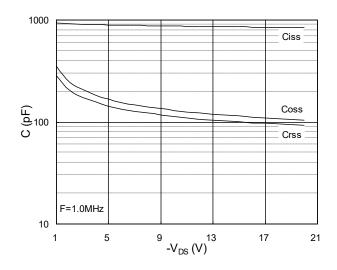


Fig.6 Normalized  $R_{DSON}$  vs.  $T_J$ 





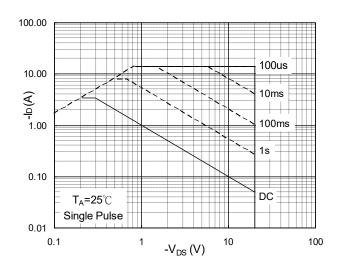


Fig.7 Capacitance

Fig.8 Safe Operating Area

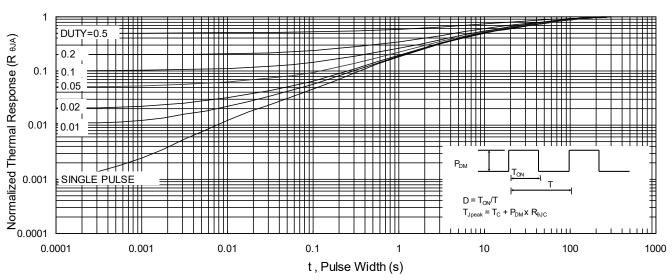
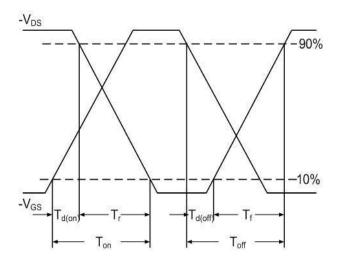


Fig.9 Normalized Maximum Transient Thermal Impedance



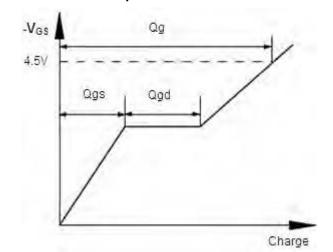
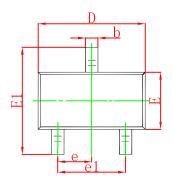


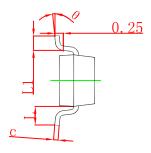
Fig.10 Switching Time Waveform

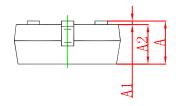
Fig.11 Gate Charge Waveform



# SOT-23 (SOT-23S) Package Outline Dimensions

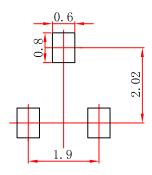






Cumbal	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min	Max	Min	Max	
Α	0.900	1.150	0.035	0.045	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.050	0.035	0.041	
b	0.300	0.500	0.012	0.020	
С	0.080	0.150	0.003	0.006	
D	2.800	3.000	0.110	0.118	
E	1.200	1.400	0.047	0.055	
E1	2.250	2.550	0.089	0.100	
е	0.950 TYP		0.037 TYP		
e1	1.800	2.000	0.071	0.079	
L	0.550	0.022 REF		REF	
L1	0.300	0.500	0.012	0.020	
θ	0°	8°	0°	8°	

# **SOT-23 Suggested Pad Layout**



### Note:

- 1.Controlling dimension:in millimeters.
- 2.General tolerance:± 0.05mm.
  3.The pad layout is for reference purposes only.



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